

SP1 to SP1F Module Package Data Sheet Clarification Errata

Clarifications/Corrections to the Data Sheet:

In the device data sheets listed below, the following clarifications and corrections should be noted. Please check the Microchip website for any existing issues.

Part Number	Part Configuration	Technology	Data Sheet Revision Level ⁽¹⁾
APTC60AM24T1G	Phase leg	Si MOSFET	1
APTC60AM35T1G	Phase leg	Si MOSFET	1
APTC60AM45B1G	PFC + Bypass + Phase leg	Si MOSFET	1
APTC60AM45BC1G	PFC + Bypass + Phase leg	Si MOSFET	1
APTC60AM45T1G	Phase leg	Si MOSFET	1
APTC60DDAM45T1G	Dual boost chopper	Si MOSFET	2
APTC60DDAM70T1G	Dual boost chopper	Si MOSFET	2
APTC60HM45T1G	Full bridge	Si MOSFET	1
APTC60HM70T1G	Full bridge	Si MOSFET	1
APTC60SKM24CT1G	Buck chopper	Si MOSFET	1
APTC60SKM24T1G	Buck chopper	Si MOSFET	1
APTC60VDAM45T1G	Interleaved PFC	Si MOSFET	1
APTC80H15T1G	Full bridge	Si MOSFET	1
APTCV40H60CT1G	Full bridge	Si MOSFET	1
APTDFA100H601G	Full bridge	Si Diode	1
APTDFA30H1201G	Full bridge	Si Diode	1
APTDFA30H601G	Full bridge	Si Diode	3
APTDFA60H1201G	Full bridge	Si Diode	1
APTDFA60H601G	Full bridge	Si Diode	1
APTDR40X1601G	Three Phase bridge	Si Diode	2
APTDR90X1601G	Three Phase bridge	Si Diode	2
APTGL40H120T1G	Full bridge	IGBT	1
APTGL90A120T1G	Phase leg	IGBT	1
APTGL90DA120T1G	Boost chopper	IGBT	1
APTGLQ100A65T1G	Phase leg	IGBT	2
APTGLQ100DA120T1G	Boost chopper	IGBT	0
APTGLQ25H120T1G	Full bridge	IGBT	1
APTGLQ40H120T1G	Full bridge	IGBT	0

Note 1: The revision level is referenced in the margin or footer of the data sheet.

SP1 TO SP1F MODULE PACKAGE

Part Number	Part Configuration	Technology	Data Sheet Revision Level ⁽¹⁾
APTGLQ50H65T1G	Full bridge	IGBT	0
APTGLQ75H65T1G	Full bridge	IGBT	1
APTGT100A60T1G	Phase leg	IGBT	1
APTGT100DA120T1G	Boost chopper	IGBT	1
APTGT100DA60T1G	Boost chopper	IGBT	1
APTGT150A60T1G	Phase leg	IGBT	1
APTGT150DA60T1G	Boost chopper	IGBT	1
APTGT150SK60T1G	Buck chopper	IGBT	1
APTGT20H60T1G	Full bridge	IGBT	1
APTGT20TL601G	Three level inverter	IGBT	1
APTGT30A170T1G	Phase leg	IGBT	1
APTGT30H60T1G	Full bridge	IGBT	1
APTGT30TL601G	Three level inverter	IGBT	1
APTGT35A120T1G	Phase leg	IGBT	1
APTGT50A120T1G	Phase leg	IGBT	1
APTGT50A170T1G	Phase leg	IGBT	1
APTGT50DH60T1G	Asymmetrical bridge	IGBT	1
APTGT50H60T1G	Full bridge	IGBT	1
APTGT50SK170T1G	Buck chopper	IGBT	1
APTGT50TL601G	Three level inverter	IGBT	1
APTGT75A60T1G	Phase leg	IGBT	1
APTGT75A120T1G	Phase leg	IGBT	1
APTGT75DA60T1G	Boost chopper	IGBT	1
APTGT75H60T1G	Full bridge	IGBT	1
APTGTQ100A65T1G	Phase leg	IGBT	1
APTGTQ100DA65T1G	Boost chopper	IGBT	1
APTGTQ100SK65T1G	Buck chopper	IGBT	1
APTM100SK33T1G	Buck chopper	Si MOSFET	1
APTM120DA30CT1G	Boost chopper	Si MOSFET	1
APTM120DA30T1G	Boost chopper	Si MOSFET	1
APTM120H140FT1G	Full bridge	Si MOSFET	1
APTM50H15FT1G	Full bridge	Si MOSFET	1
APTM60A11FT1G	Phase leg	Si MOSFET	1
APTM60H23FT1G	Full bridge	Si MOSFET	1
MSCDC50H1201AG	Full Bridge	SiC Diode	1
MSCDC50H1701AG	Full Bridge	SiC Diode	1
MSCDC50H701AG	Full Bridge	SiC Diode	1
MSCDC50X1201AG	3 Phase Bridge	SiC Diode	1
MSCDC50X1701AG	3 Phase Bridge	SiC Diode	1
MSCDC50X701AG	3 Phase Bridge	SiC Diode	1
MSCGTQ100HD65C1AG	Vienna PFC	IGBT	0
MSCSM120AM16CT1AG	Phase Leg	SiC MOSFET	1

Note 1: The revision level is referenced in the margin or footer of the data sheet.

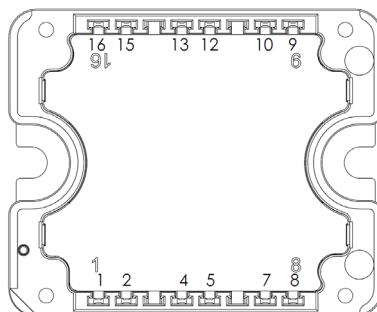
Part Number	Part Configuration	Technology	Data Sheet Revision Level ⁽¹⁾
MSCSM120AM31CT1AG	Phase Leg	SiC MOSFET	1
MSCSM120AM50CT1AG	Phase Leg	SiC MOSFET	1
MSCSM170AM23CT1AG	Phase Leg	SiC MOSFET	A
MSCSM170AM45CT1AG	Phase Leg	SiC MOSFET	A
MSCSM70AM19CT1AG	Phase Leg	SiC MOSFET	1

Note 1: The revision level is referenced in the margin or footer of the data sheet.

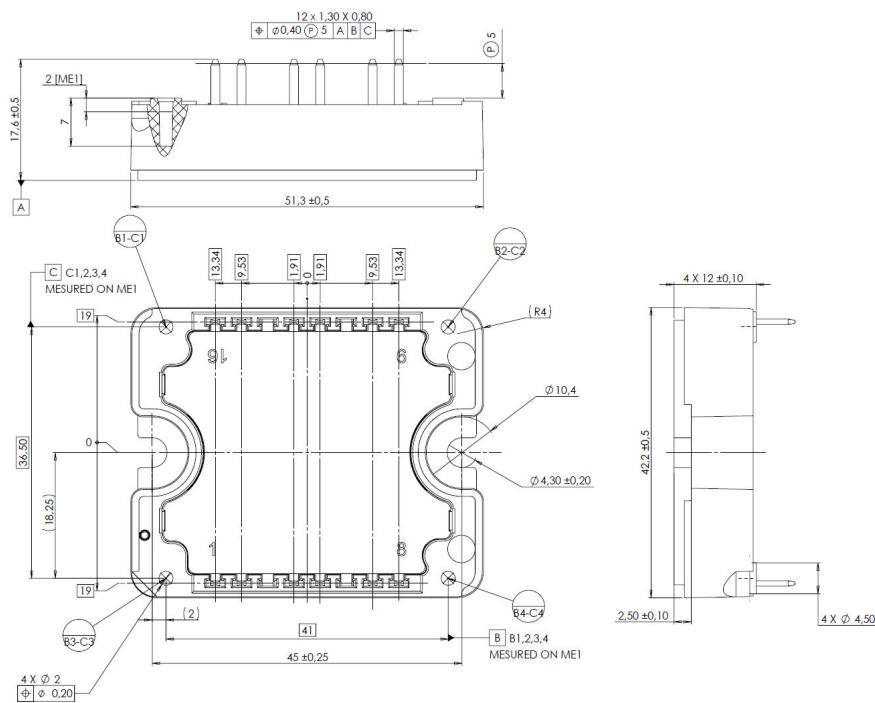
SUMMARY OF CHANGE

The package was changed from SP1 to SP1F.

Refer to Application Note AN3500 "Mounting Instructions for SP1F and SP3F Power Modules." The pinout location diagram is replaced by this drawing.

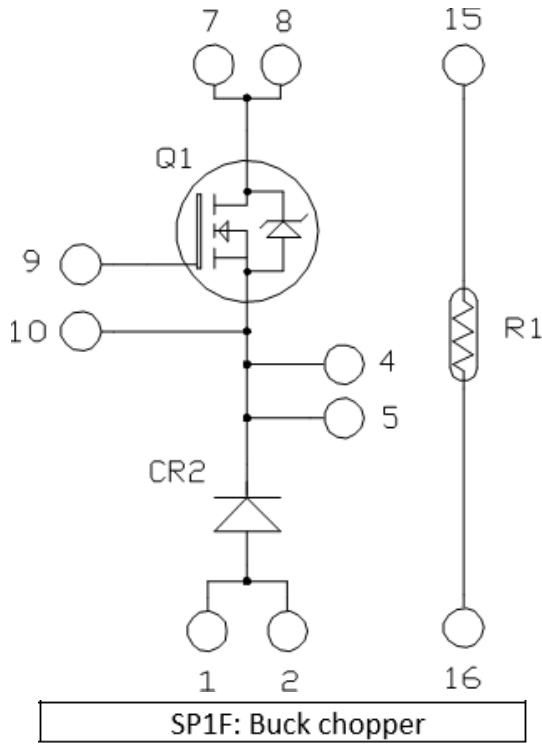
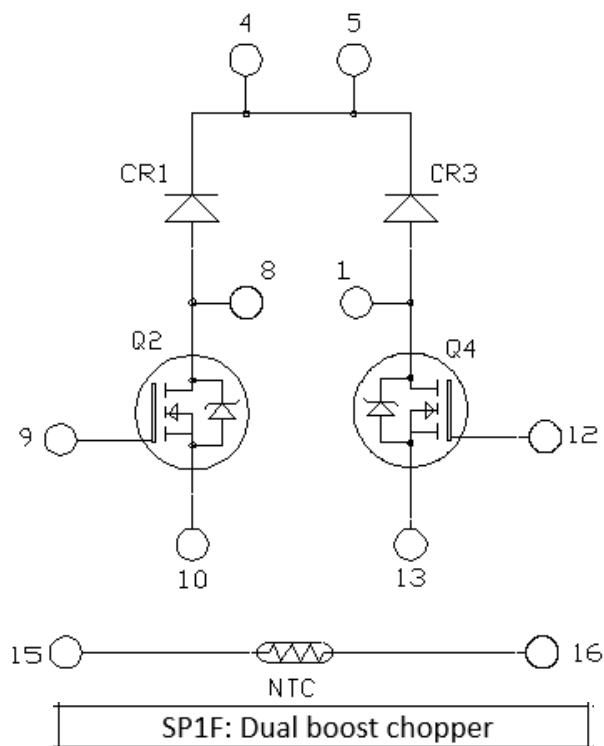
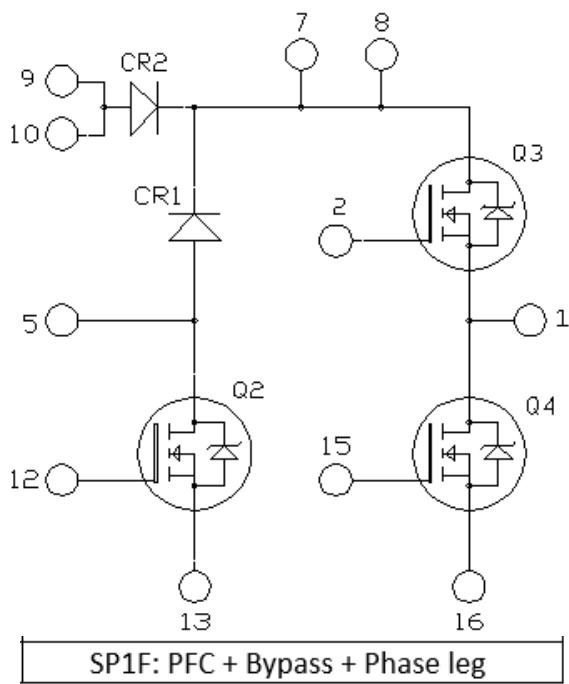
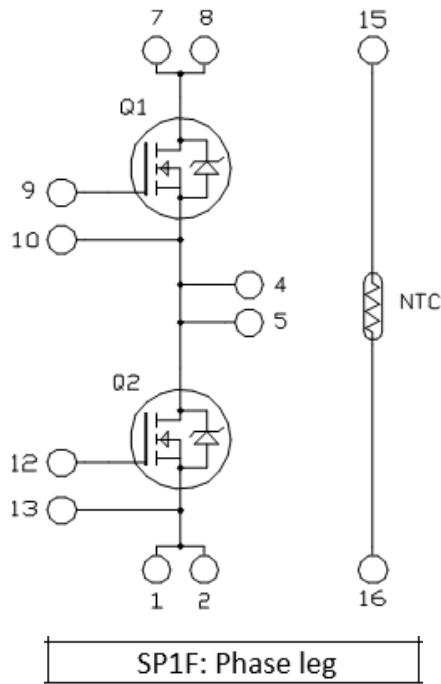


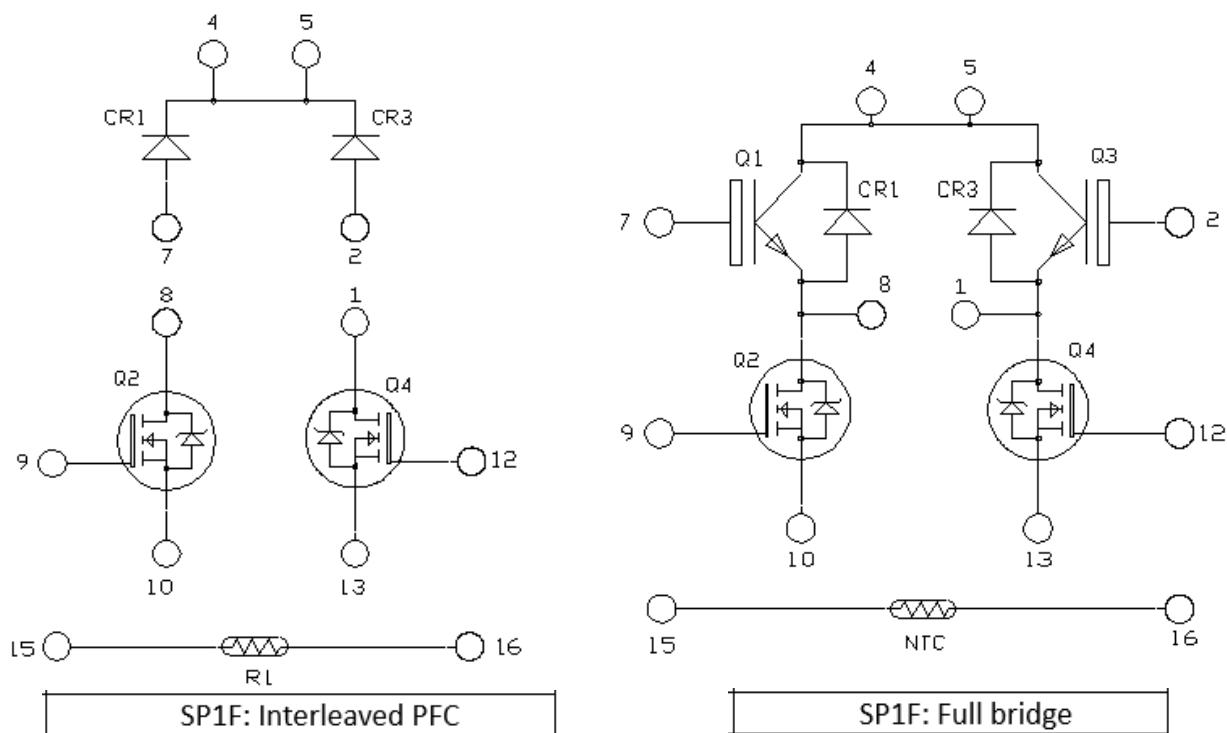
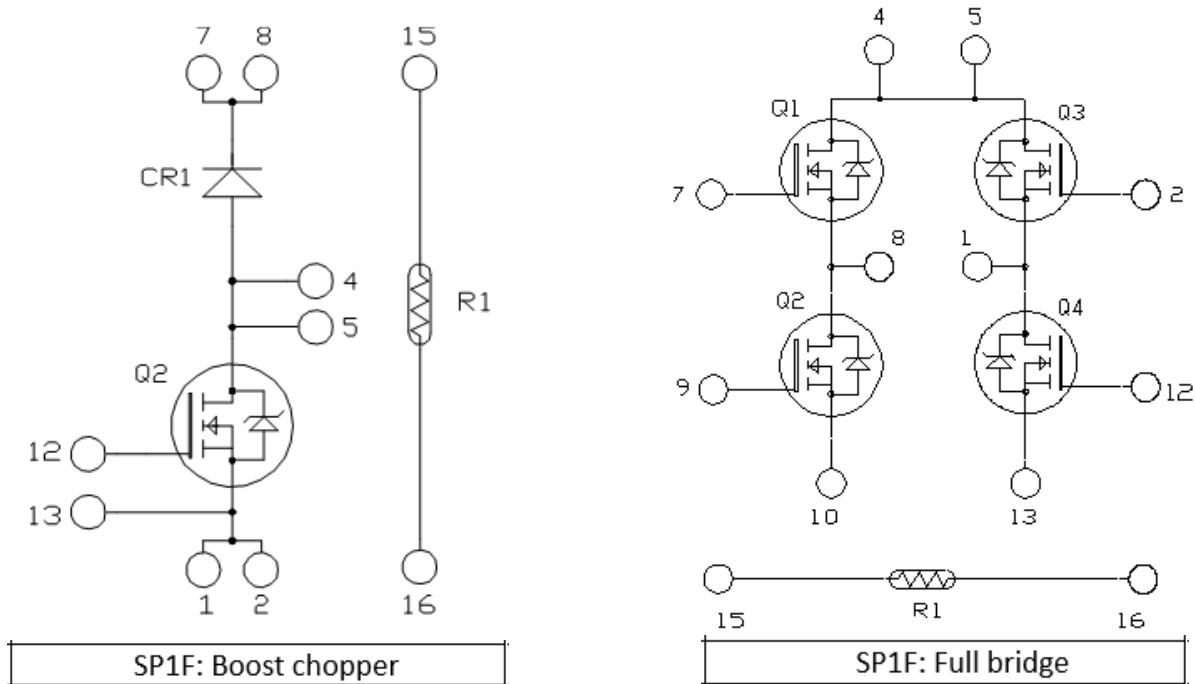
The package outline drawing is replaced by this drawing. The dimensions in the following figure are in millimeters:

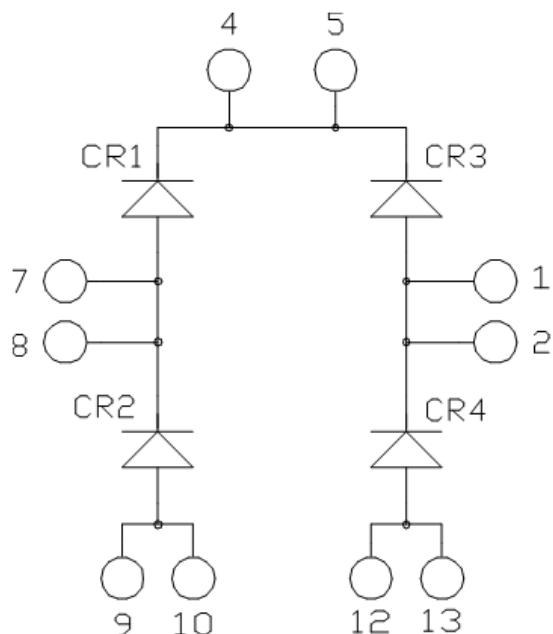


SP1 TO SP1F MODULE PACKAGE

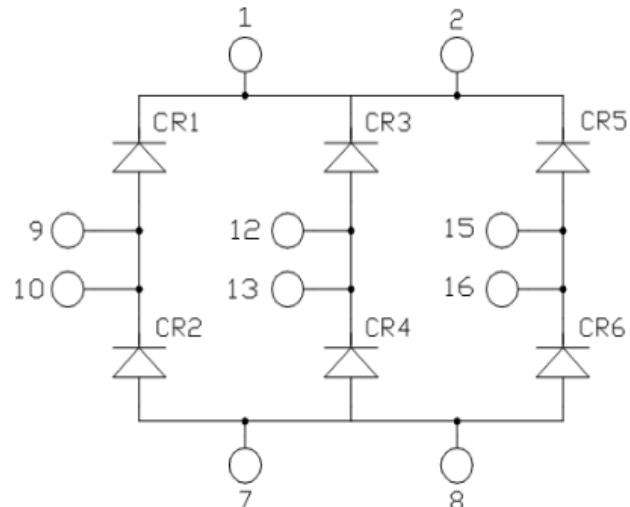
The Package schematic is replaced by this drawing, based on part configuration.



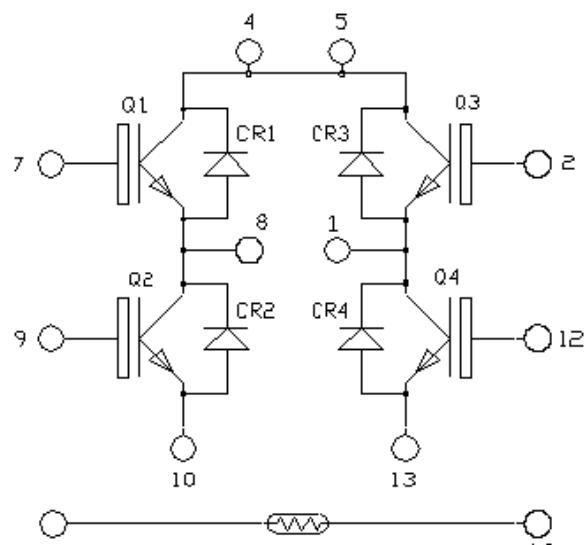




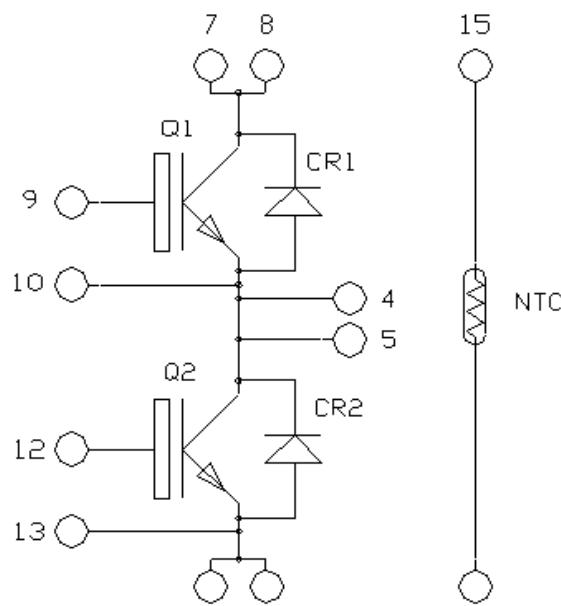
SP1F: Diode Full bridge



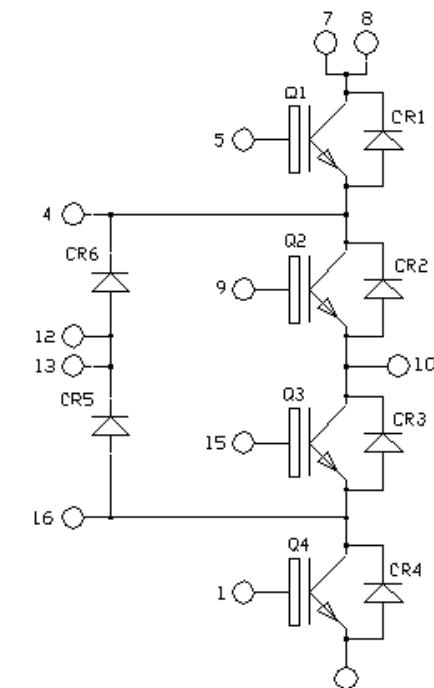
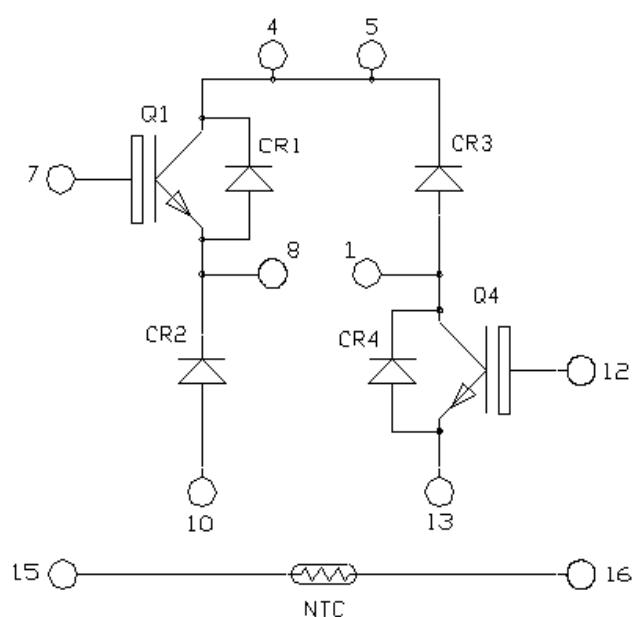
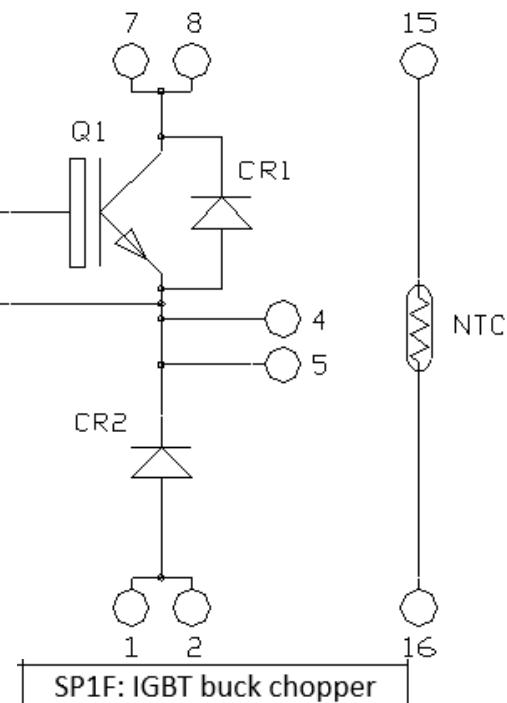
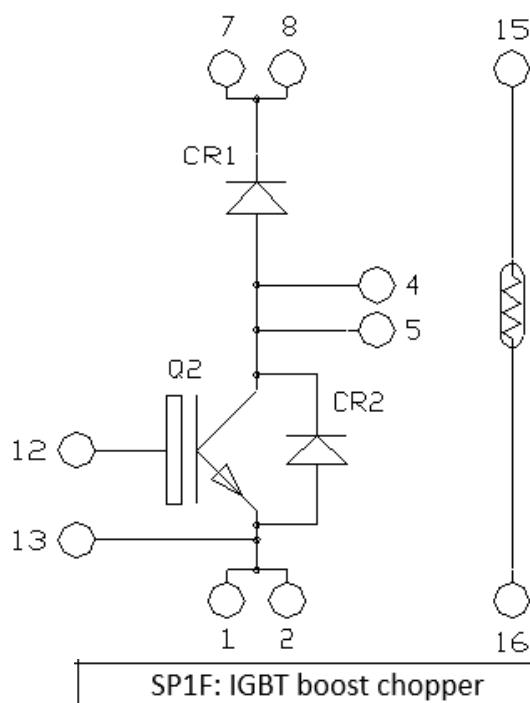
SP1F: Diode 3 phase bridge



SP1F: IGBT full bridge



SP1F: IGBT Phase leg



**APPENDIX A: DOCUMENT
REVISION HISTORY**

Rev B Document (10/2023)

Added SP1F package schematic changes.

Rev A Document (07/2023)

Initial release of this document.

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